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	cistant Commissions for Date	04-06-1998	
AS	sistant Commissioner for Pater	100674228	ocument.
1.	Name of conveying party(ies): Shunpei Yamazaki		 Name and address of receiving party(ies): Semiconductor Energy Laboratory Co., Ltd. 398, Hase, Atsugi-shi
	Additional name(s) attached? Yes	es ■ No	Kanagawa-ken 243-0036 Japan
3.	Nature of conveyance: ■ Assignment □ Merger □ Security Agreement □ Change of Name □ Other: Execution Date: 3/6/98		Additional names/addresses attached? ☐ Yes ■ No
4.	Application number(s) or patent null fithis document is being filed with A. Patent Application No.(s): 08/963,977	a new application, the execut	ution date of the application is: B. Patent No.(s):
		Additional numbers attac	ached? □ Yes ■ No
5.	Name/address of party to whom co concerning document should be m		6. Total number of applications/patents involved: 1
	Scott C. Harris, Reg. No. 32,030 Fish & Richardson P.C. 4225 Executive Square, Suite 14		 7. Total fee (37 CFR 3.41): \$40 ■ Enclosed □ Authorized to charge deposit account
	La Jolla, CA 92037	8.	 Deposit account number: 06-1050 If the fee above is being charged to deposit account a duplicate copy of this cover sheet is attached. Please apply any additional charges, or any credits, to our Deposit Account No. 06-1050.
		DO NOT USE THIS	S SPACE
9.	Statement and signature: To the be attached is the original document. Scott C. Harris, Reg. No. 32,030	est of my knowledge and beli	elief, the foregoing information is true and correct and the $3/93/97$
	Name of Person Signing	Signature of pages including cover shee	Date Date et, attachments, and document: 3

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3-23-98 Date of Deposit _ I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated above and is

addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

FISH & RICHARDSON P.C.

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned hereby assign(s), transfer(s) and set(s) over to:

SEMICONDUCTOR ENERGY LABORATORY CO., LTD.

having the address:

398, Hase, Atsugi-shi, Kanagawa-ken 243-0036 Japan

(hereinafter designated as the "ASSIGNEE"), its successors and assigns, the entire right, title, and interest for the United States in the invention, and all applications for patent and any Letters Patent which may be granted therefor, including said application, and all United States Letters Patents which may be granted therefor, and all divisions, reissues, continuations and extensions thereof, the said interest being the entire ownership of said Letters Patent when granted to be held by said ASSIGNEE, its successors, assigns or their legal representatives, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been and enjoyed by Assignor(s) if this assignment had not been made, the application being known by the Title:

SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF

Attorney Docket No: 07977/196001

for which the undersigned has/have executed an application for patent in the United States of America on the same day herewith. Where this instrument is not filed concurrently with the application, the following identifying information may be added after execution:

Serial No. 08/963,977 Filing Date: November 4, 1997

- 1. The undersigned hereby agree(s) to sign and execute any further documents and instruments which may be necessary, lawful and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue application or in any amendments, extension or interference proceedings, or otherwise to secure the title thereto to the ASSIGNEE.
- 2. The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

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- 3. The undersigned agree to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the ASSIGNEE.
- 4. The undersigned hereby authorize(s) and request(s) the Commissioner of Patents in the United States to issue any and all Letters Patents resulting from said application or any division or divisions or continuing applications thereof to the said ASSIGNEE.
- 5. The undersigned hereby grant(s) to the firm of Fish & Richardson P.C. the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

March 6, 1998 Date	Typed Name: Shympei YAMAZAKI	
Date	Typed Name:	
Date	Typed Name:	
This assignment maulso sign here:	ly be signed before a U.S. Notary Public or before at least two	witnesses who
Date	Typed Name:	
	· ·	
Date	Typed Name:	

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